


**Features :**

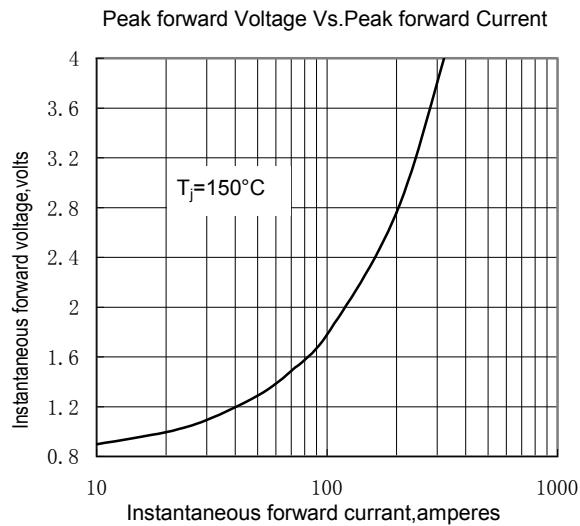
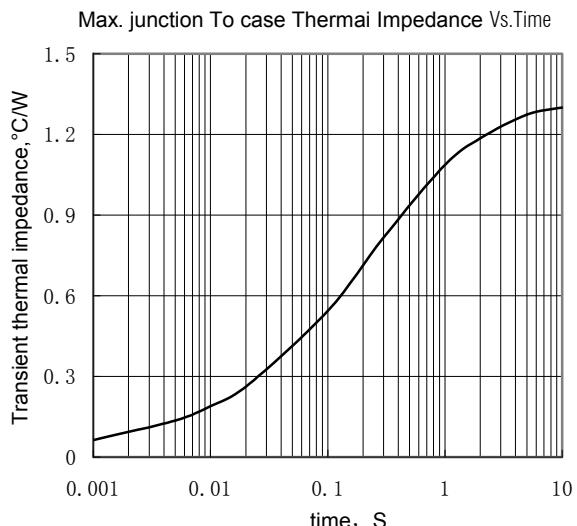
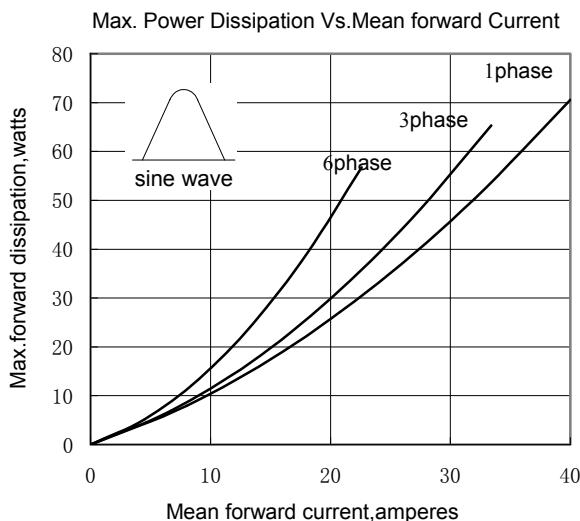
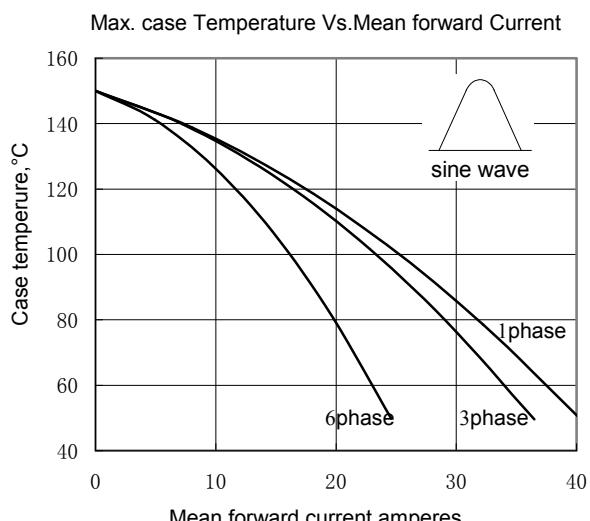
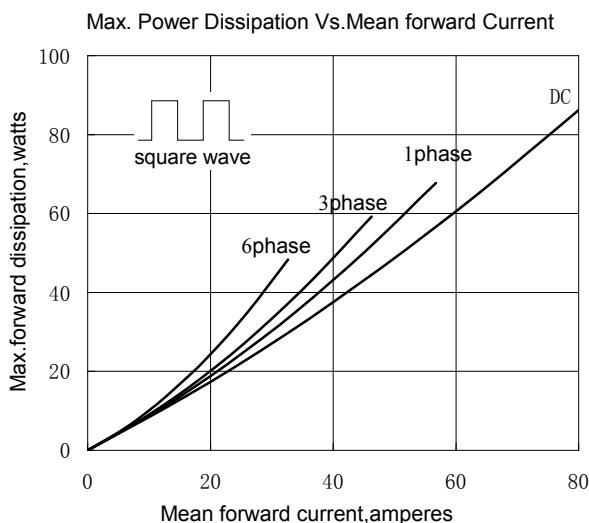
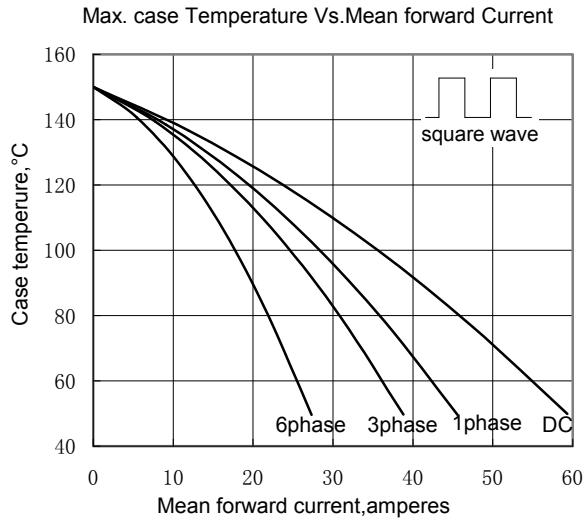
- High performance thermal insulation materials
- Good thermal fatigue performance
- International standard package

**Typical Applications**

- Various rectifiers
- DC supply for PWM inverter

$V_{RSM}$	$V_{RRM}$	Type & Outline
900V	800V	MDx26-08
1100V	1000V	MDx26-10
1300V	1200V	MDx26-12
1500V	1400V	MDx26-14
1700V	1600V	MDx26-16
1900V	1800V	MDx26-18

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	$T_j(^{\circ}\text{C})$	VALUE			UNIT
				Min	Type	Max	
$I_{F(AV)}$	Mean forward current	180° half sine wave 50Hz Single side cooled, $T_c=100^{\circ}\text{C}$	150			26	A
$I_{F(RMS)}$	RMS forward current		150			41	A
$I_{RRM}$	Repetitive peak current	at $V_{RRM}$	150			8	mA
$I_{FSM}$	Surge forward current	10ms half sine wave	150			0.65	KA
$I^2t$	$I^2T$ for fusing coordination	$V_R=0.6V_{RRM}$				2.1	$\text{A}^2\text{s} \times 10^3$
$V_{FO}$	Threshold voltage		150			0.80	V
$r_F$	Forward slop resistance					6.80	$\text{m}\Omega$
$V_{FM}$	Peak forward voltage	$I_{FM}= 80 \text{ A}$	25			1.45	V
$R_{th(j-c)}$	Thermal resistance Junction to case	At 180° sine Single side cooled per chip				1.30	$^{\circ}\text{C}/\text{W}$
$R_{th(c-h)}$	Thermal resistance case to heatsink	At 180° sine Single side cooled per chip				0.2	$^{\circ}\text{C}/\text{W}$
$V_{iso}$	Isolation voltage	50Hz,R.M.S,t=1min, $I_{iso}:1\text{mA(max)}$		2500			V
$F_m$	Terminal connection torque(M5)				4.0		$\text{N}\cdot\text{m}$
	Mounting torque(M6)				6.0		$\text{N}\cdot\text{m}$
$T_{stg}$	Stored temperature			-40		125	$^{\circ}\text{C}$
$W_t$	Weight				105		g
Outline		M01H					


**Fig.1**

**Fig.2**

**Fig.3**

**Fig.4**

**Fig.5**

**Fig.6**

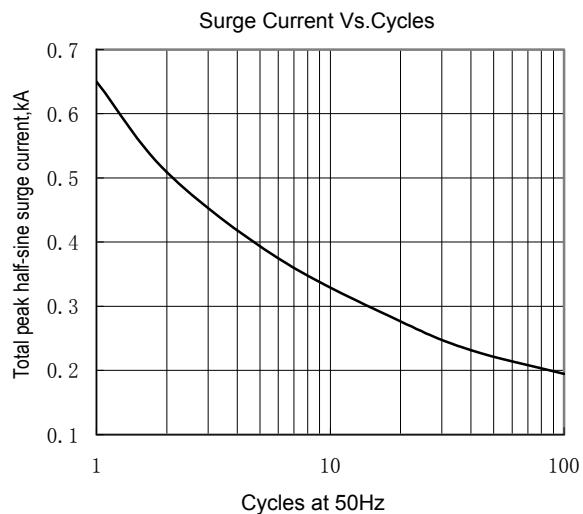


Fig.7

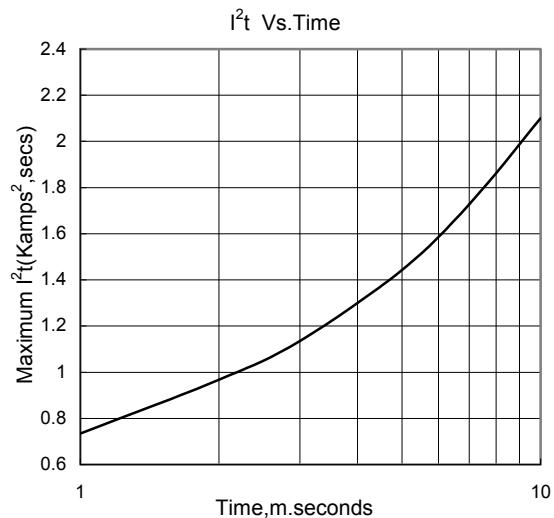
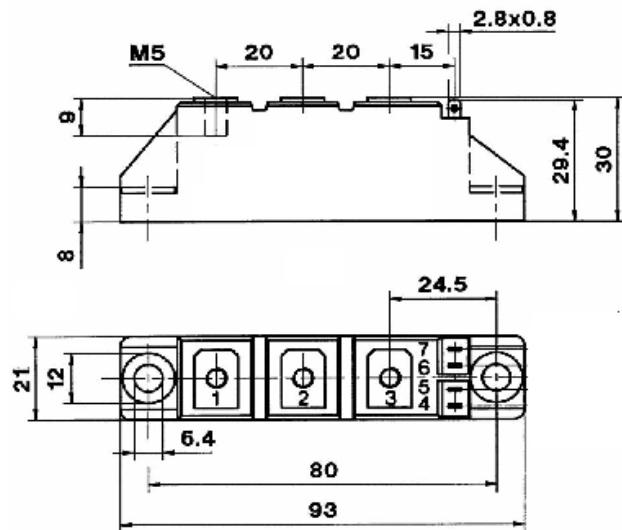


Fig.8

**Outline:**



**M01H**

